

[illegible]



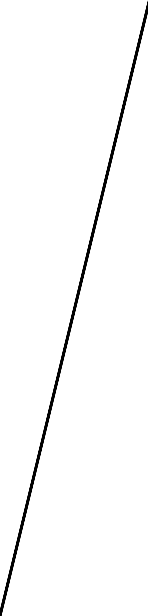
N 塑封封装 道 场效应管。

RDS(ON)导通电阻小，SOT23-3 封装，无卤产品。
Low RDS(ON),SOT23-3 package,HF Product.

电池管庞



			~	°C
	≤			°C



[illegible]

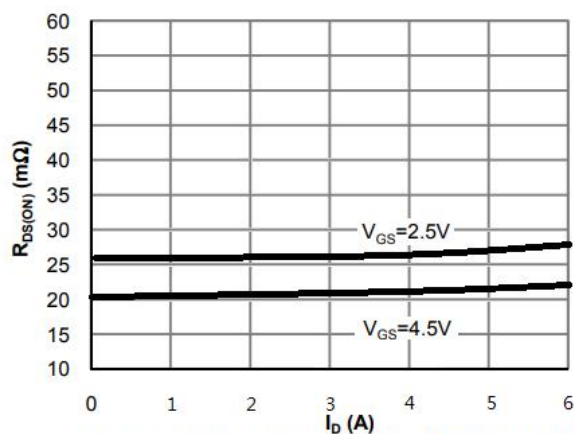
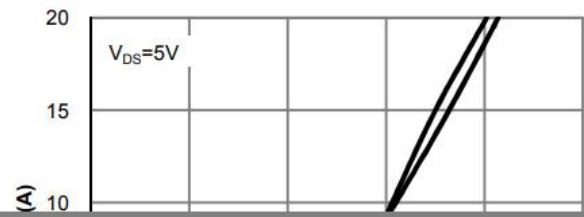
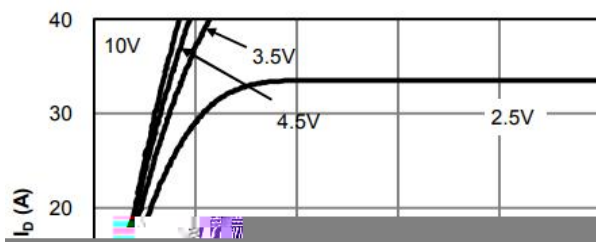


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

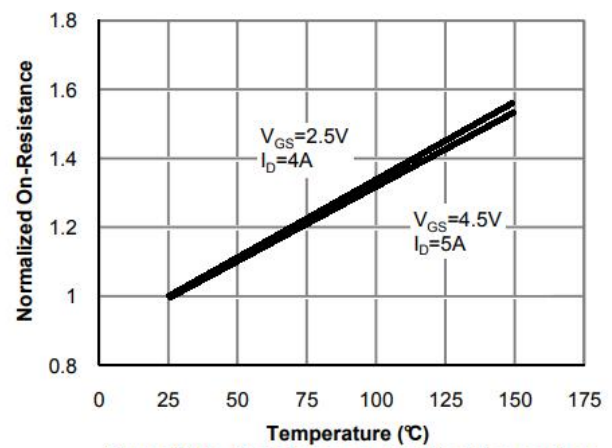


Figure 4: On-Resistance vs. Junction Temperature



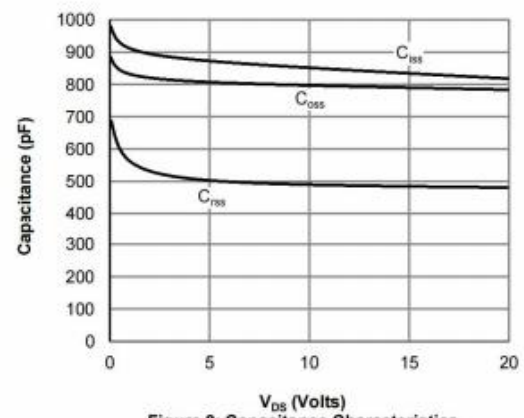
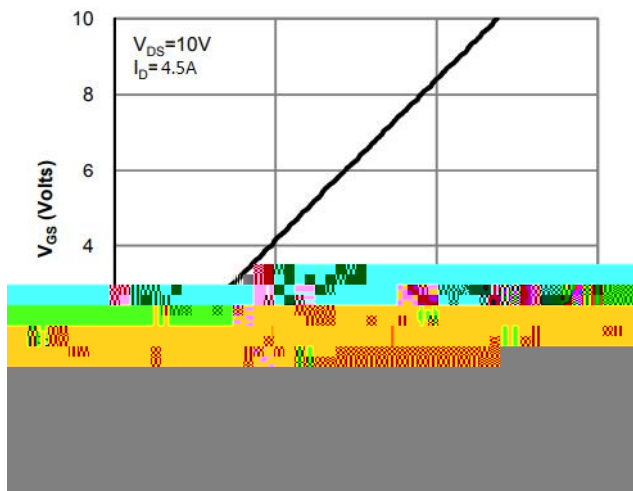
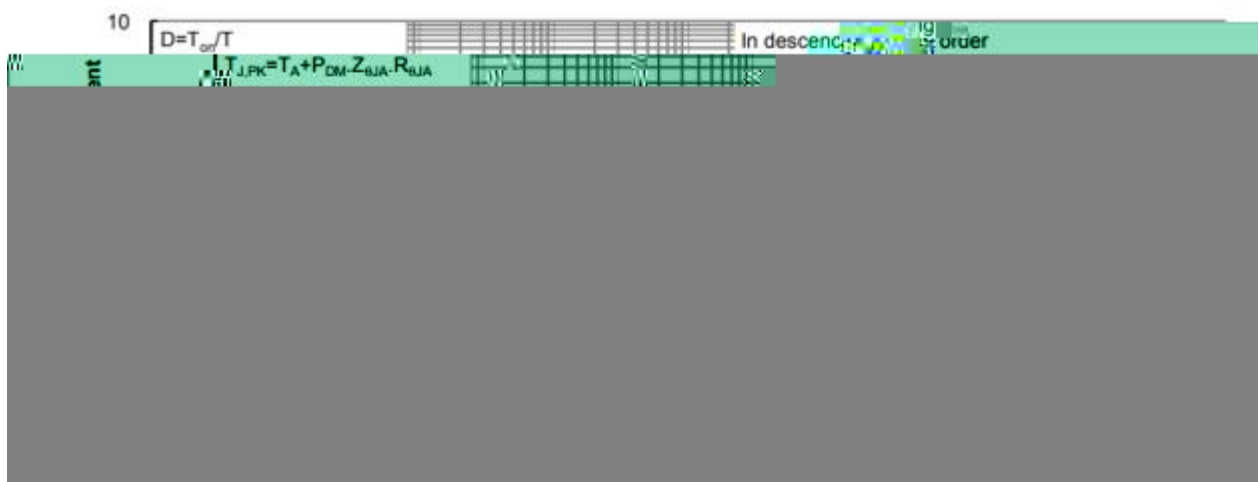
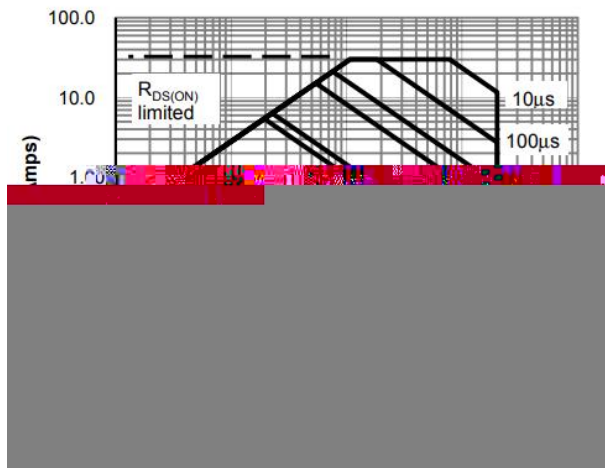
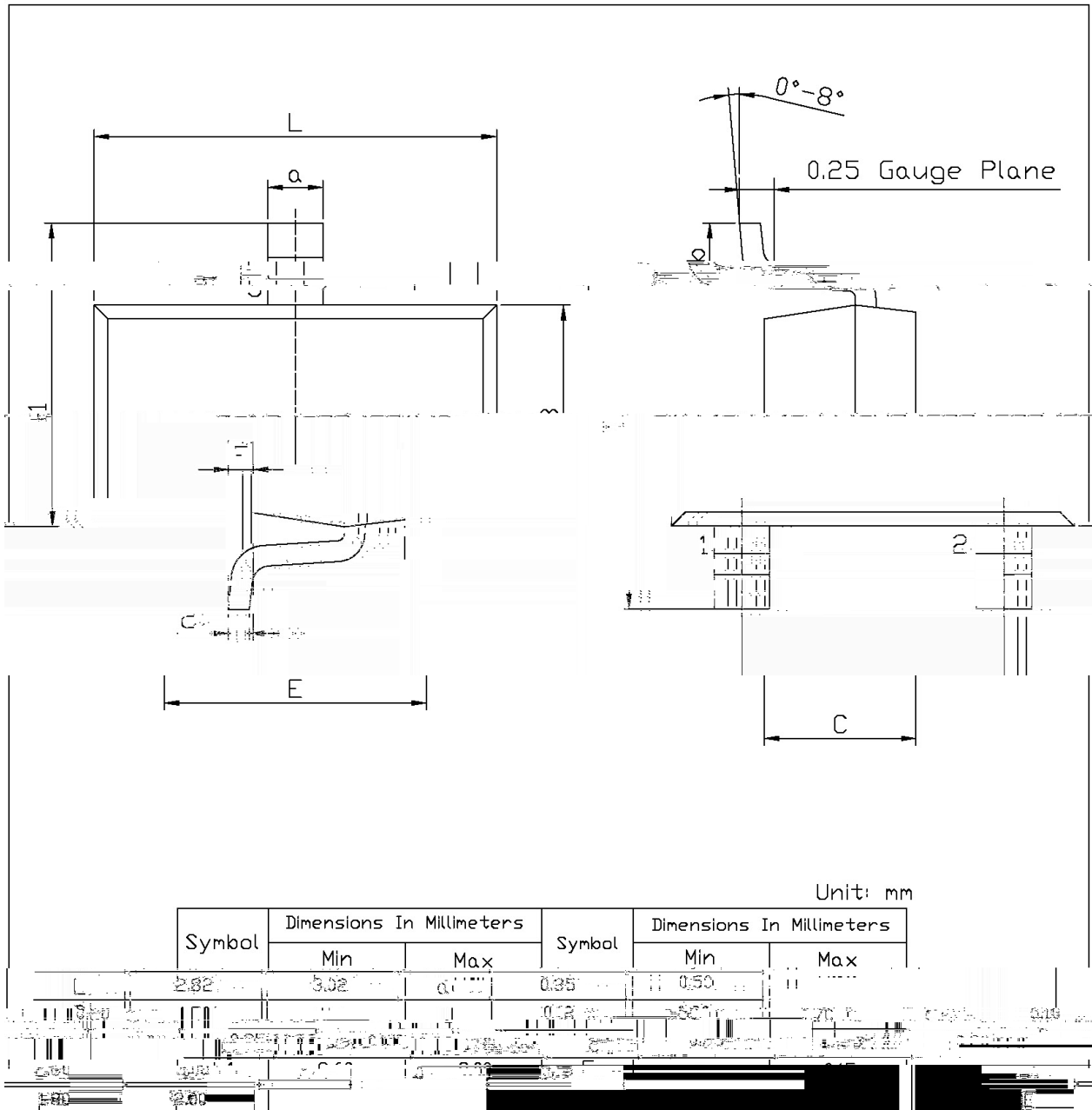
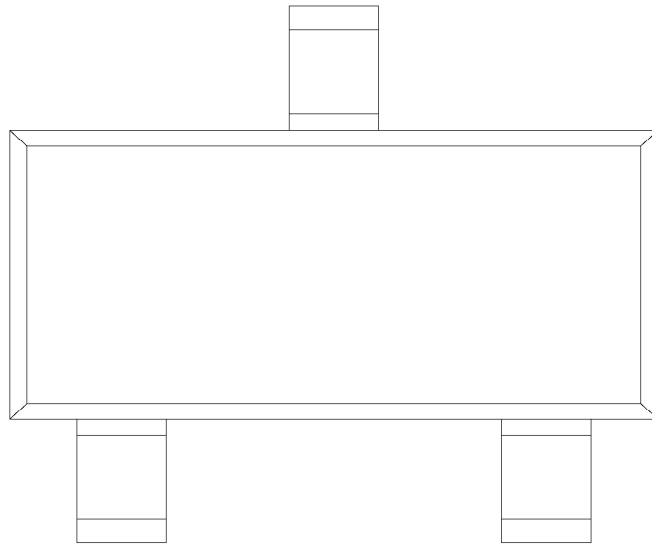


Figure 8: Capacitance Characteristics









Temperature Profile for IR Reflow Soldering(Pb-Free)

± °C ± °C ± °C ± °C

± °C ± °C ± °C ± °C